

SGL160N60UF

Ultra-Fast IGBT

General Description

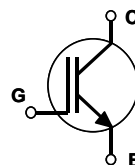
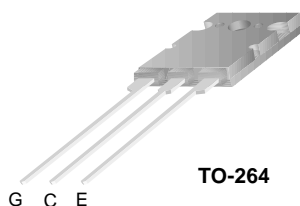
Fairchild's UF series of Insulated Gate Bipolar Transistors (IGBTs) provides low conduction and switching losses. The UF series is designed for applications such as motor control and general inverters where high speed switching is a required feature.

Features

- High speed switching
- Low saturation voltage : $V_{CE(sat)} = 2.1\text{ V @ } I_C = 80\text{ A}$
- High input impedance

Applications

AC & DC motor controls, general purpose inverters, robotics, servo controls, and power supplies.



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

| Symbol | Description | SGL160N60UF | Units |
|-------------|---|-------------|------------------|
| V_{CES} | Collector-Emitter Voltage | 600 | V |
| V_{GES} | Gate-Emitter Voltage | ± 20 | V |
| I_C | Collector Current @ $T_C = 25^\circ\text{C}$ | 160 | A |
| | Collector Current @ $T_C = 100^\circ\text{C}$ | 80 | A |
| $I_{CM(1)}$ | Pulsed Collector Current | 300 | A |
| P_D | Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ | 250 | W |
| | Maximum Power Dissipation @ $T_C = 100^\circ\text{C}$ | 100 | W |
| T_J | Operating Junction Temperature | -55 to +150 | $^\circ\text{C}$ |
| T_{stg} | Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ |
| T_L | Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds | 300 | $^\circ\text{C}$ |

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Units |
|-----------------|---|------|------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | -- | 0.5 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | -- | 25 | $^\circ\text{C/W}$ |

Electrical Characteristics of the IGBT $T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|----------------------------------|--|---|------|------|-----------|---------------------|
| Off Characteristics | | | | | | |
| BV_{CES} | Collector-Emitter Breakdown Voltage | $V_{GE} = 0V, I_C = 250\mu A$ | 600 | -- | -- | V |
| $\Delta BV_{CES}/\Delta T_J$ | Temperature Coefficient of Breakdown Voltage | $V_{GE} = 0V, I_C = 1mA$ | -- | 0.6 | -- | V/ $^\circ\text{C}$ |
| I_{CES} | Collector Cut-Off Current | $V_{CE} = V_{CES}, V_{GE} = 0V$ | -- | -- | 250 | μA |
| I_{GES} | G-E Leakage Current | $V_{GE} = V_{GES}, V_{CE} = 0V$ | -- | -- | ± 100 | nA |
| On Characteristics | | | | | | |
| $V_{GE(th)}$ | G-E Threshold Voltage | $I_C = 80mA, V_{CE} = V_{GE}$ | 3.5 | 4.5 | 6.5 | V |
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C = 80A, V_{GE} = 15V$ | -- | 2.1 | 2.6 | V |
| | | $I_C = 160A, V_{GE} = 15V$ | -- | 2.6 | -- | V |
| Dynamic Characteristics | | | | | | |
| C_{ies} | Input Capacitance | $V_{CE} = 30V, V_{GE} = 0V,$ $f = 1MHz$ | -- | 5000 | -- | pF |
| C_{oes} | Output Capacitance | | -- | 600 | -- | pF |
| C_{res} | Reverse Transfer Capacitance | | -- | 200 | -- | pF |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{CC} = 300V, I_C = 80A,$ $R_G = 3.9\Omega, V_{GE} = 15V$ Inductive Load, $T_C = 25^\circ\text{C}$ | -- | 40 | -- | ns |
| t_r | Rise Time | | -- | 101 | -- | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | -- | 90 | 130 | ns |
| t_f | Fall Time | | -- | 75 | 150 | ns |
| E_{on} | Turn-On Switching Loss | | -- | 2500 | -- | μJ |
| E_{off} | Turn-Off Switching Loss | | -- | 1760 | -- | μJ |
| E_{ts} | Total Switching Loss | -- | 4260 | 5000 | μJ | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{CC} = 300V, I_C = 80A,$ $R_G = 3.9\Omega, V_{GE} = 15V$ Inductive Load, $T_C = 125^\circ\text{C}$ | -- | 45 | -- | ns |
| t_r | Rise Time | | -- | 105 | -- | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | -- | 140 | 200 | ns |
| t_f | Fall Time | | -- | 122 | 250 | ns |
| E_{on} | Turn-On Switching Loss | | -- | 2785 | -- | μJ |
| E_{off} | Turn-Off Switching Loss | | -- | 3100 | -- | μJ |
| E_{ts} | Total Switching Loss | -- | 5885 | -- | μJ | |
| Q_g | Total Gate Charge | $V_{CE} = 300V, I_C = 80A,$ $V_{GE} = 15V$ | -- | 345 | 520 | nC |
| Q_{ge} | Gate-Emitter Charge | | -- | 60 | 100 | nC |
| Q_{gc} | Gate-Collector Charge | | -- | 95 | 150 | nC |
| L_e | Internal Emitter Inductance | Measured 5mm from PKG | -- | 18 | -- | nH |

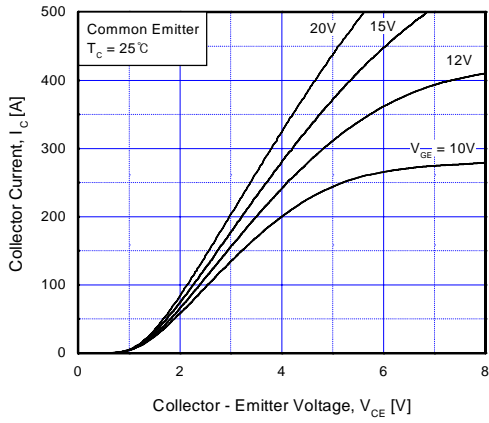


Fig 1. Typical Output Characteristics

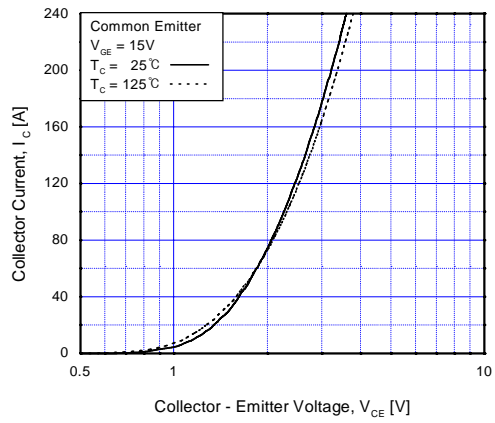


Fig 2. Typical Saturation Voltage Characteristics

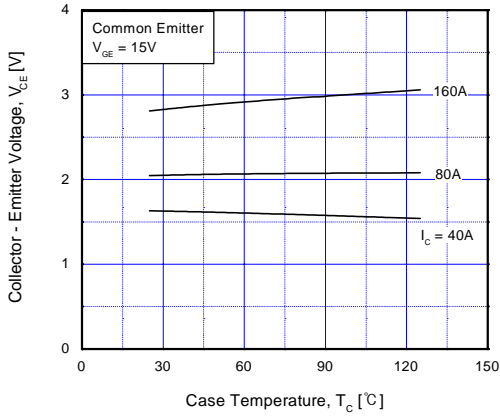


Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

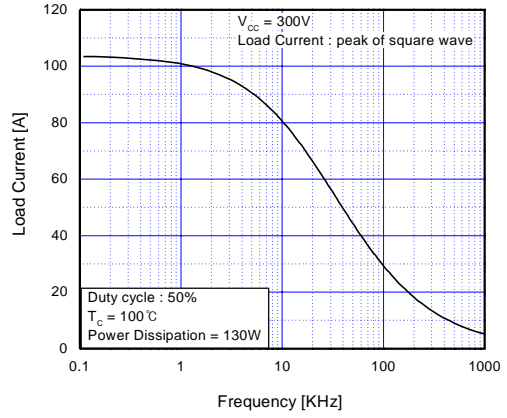


Fig 4. Load Current vs. Frequency

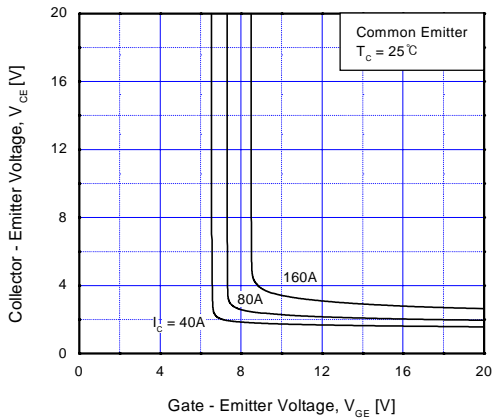


Fig 6. Saturation Voltage vs. V_{GE}

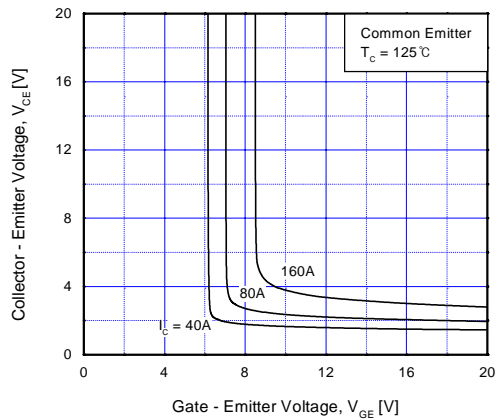


Fig 7. Saturation Voltage vs. V_{GE}

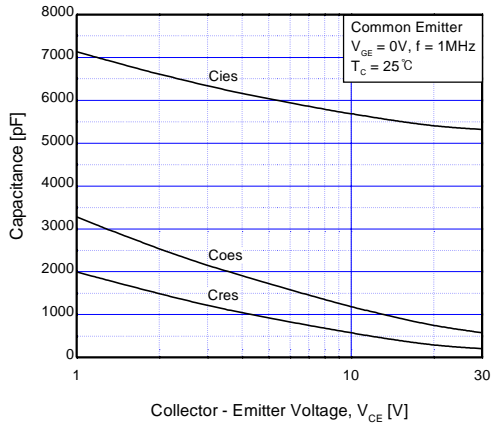


Fig 7. Capacitance Characteristics

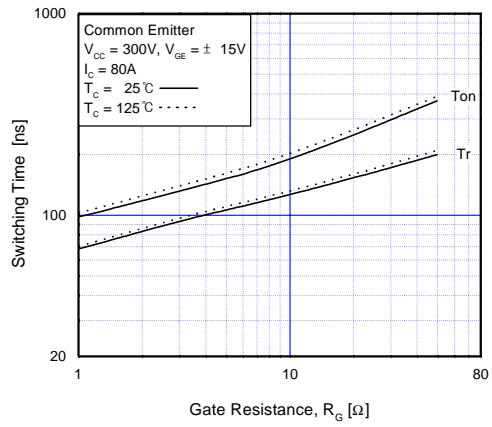


Fig 8. Turn-On Characteristics vs. Gate Resistance

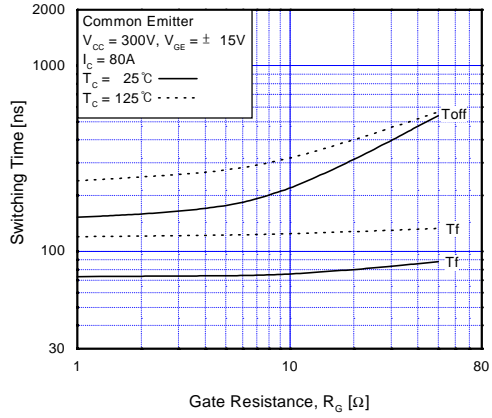


Fig 9. Turn-Off Characteristics vs. Gate Resistance

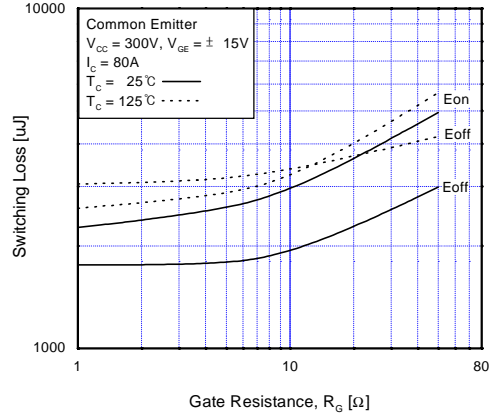


Fig 10. Switching Loss vs. Gate Resistance

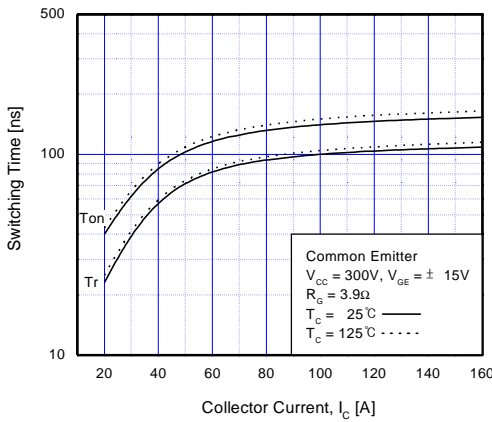


Fig 11. Turn-On Characteristics vs. Collector Current

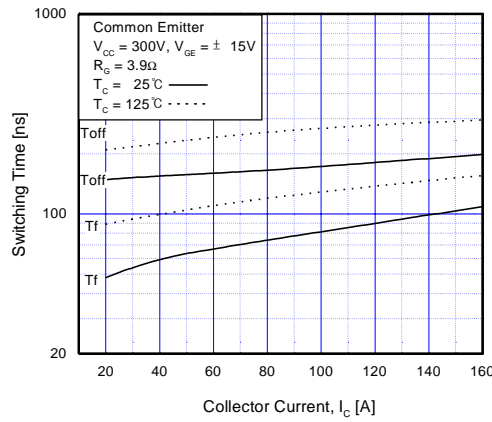


Fig 12. Turn-Off Characteristics vs. Collector Current

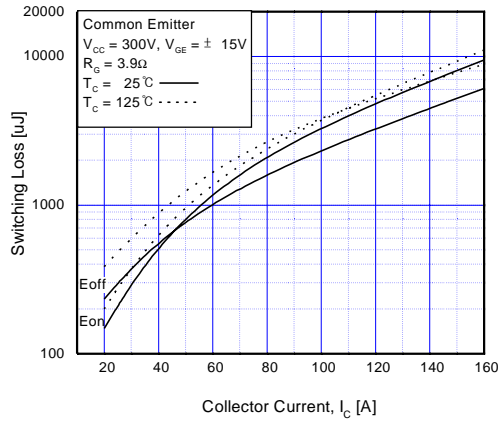


Fig 13. Switching Loss vs. Collector Current

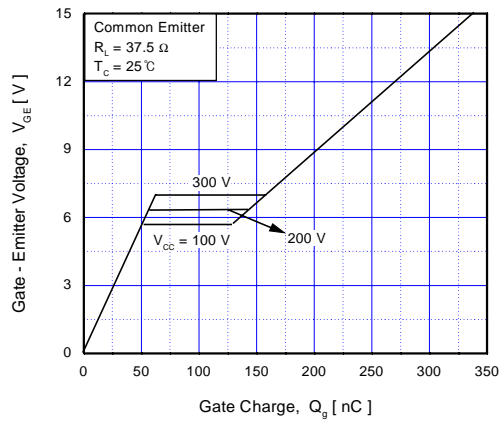


Fig 14. Gate Charge Characteristics

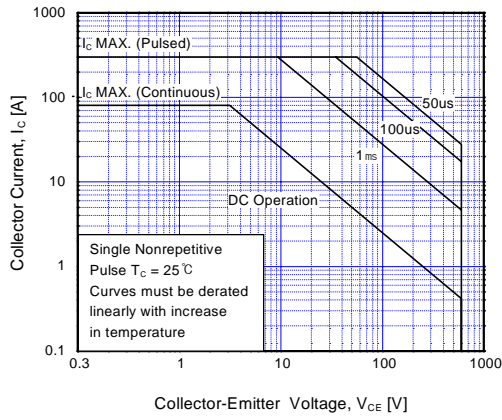


Fig 15. SOA Characteristic

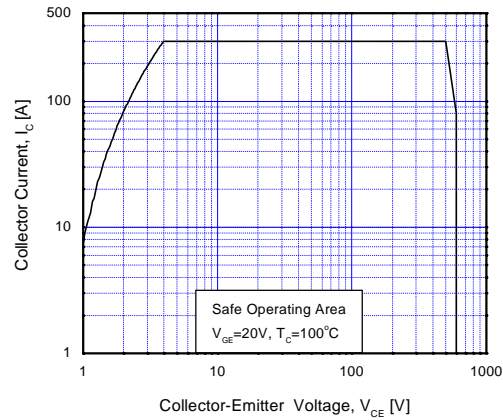


Fig 16. Turn-Off SOA Characteristics

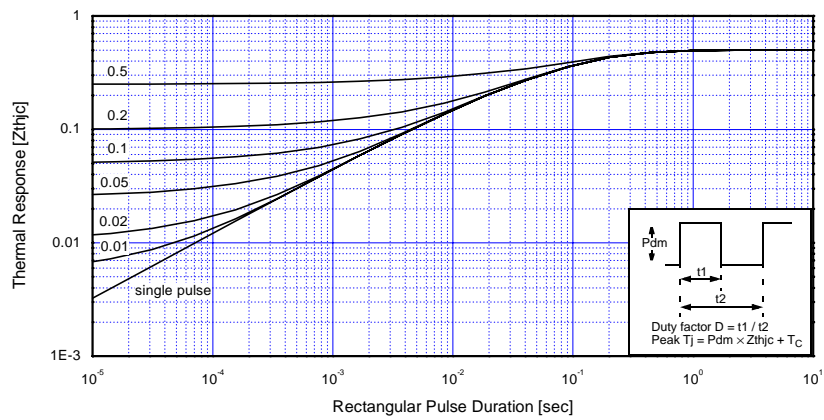
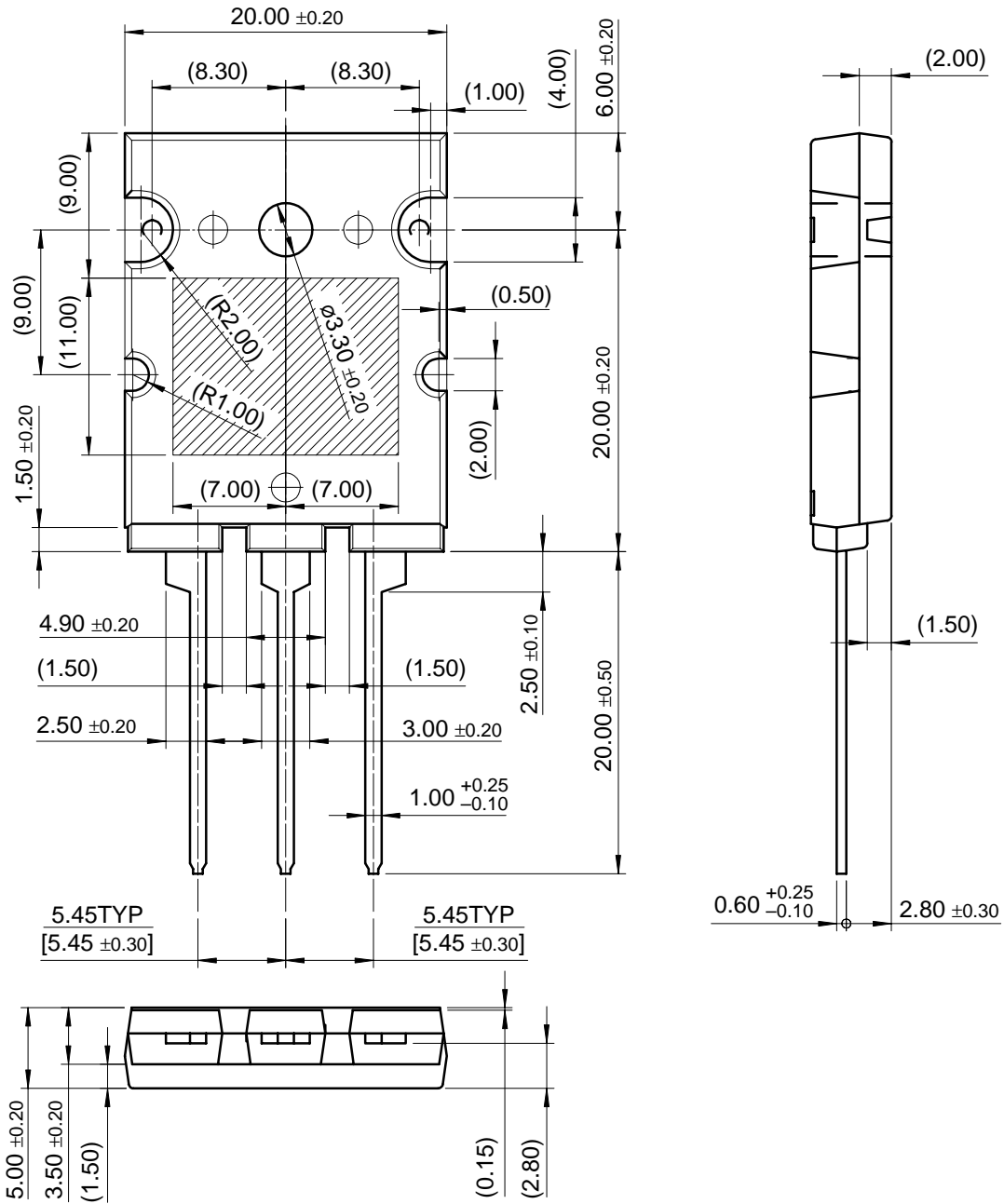


Fig 17. Transient Thermal Impedance of IGBT

Package Dimension

TO-264

SGL160N60UF



Dimensions in Millimeters

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

| | | | | |
|----------------------|---------------------|---------------------|------------------|-----------|
| ACEx™ | FAST® | MICROWIRE™ | SLIENT SWITCHER® | UHC™ |
| Bottomless™ | FASTr™ | OPTOLOGIC™ | SMART START™ | UltraFET® |
| CoolFET™ | FRFET™ | OPTOPLANAR™ | SPM™ | VCX™ |
| CROSSVOLT™ | GlobalOptoisolator™ | PACMAN™ | STAR*POWER™ | |
| DenseTrench™ | GTO™ | POPT™ | Stealth™ | |
| DOMETM | HiSeC™ | Power247™ | SuperSOT™-3 | |
| EcoSPARK™ | I ² C™ | PowerTrench® | SuperSOT™-6 | |
| E ² CMOS™ | ISOPLANAR™ | QFET™ | SuperSOT™-8 | |
| EnSigna™ | LittleFET™ | QST™ | SyncFET™ | |
| FACT™ | MicroFET™ | QT Optoelectronics™ | TinyLogic™ | |
| FACT Quiet Series™ | MicroPak™ | Quiet Series™ | TruTranslation™ | |

STAR*POWER is used under license

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Datasheet Identification | Product Status | Definition |
|--------------------------|------------------------|---|
| Advance Information | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| No Identification Needed | Full Production | This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| Obsolete | Not In Production | This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only. |